- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

## description

These devices contain four independent 2-input NOR buffer gates.

The SN5428, and SN54LS28 are characterized for operation over the full military temperature range of -55°C to 125°C. The SN7428, and SN74LS28 are characterized for operation from 0°C to 70°C.

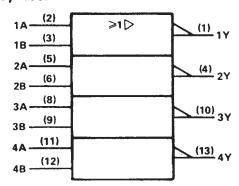
#### **FUNCTION TABLE (each gate)**

| INP | UTS | ОИТРИТ |
|-----|-----|--------|
| A   | В   | Y      |
| Н   | Х   | L      |
| х   | Н   | Ł      |
| L   | L   | н      |

## positive logic

$$Y = \overline{A + B}$$
 or  $Y = \overline{A \cdot B}$ 

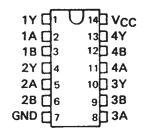
#### logic symbol†



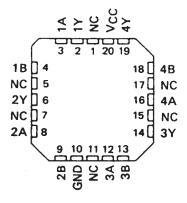
<sup>&</sup>lt;sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.

SN5428, SN54LS28...J OR W PACKAGE SN7428...N PACKAGE SN74LS28...D OR N PACKAGE (TOP VIEW)

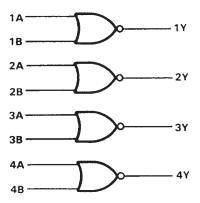


SN54LS28 . . . FK PACKAGE (TOP VIEW)

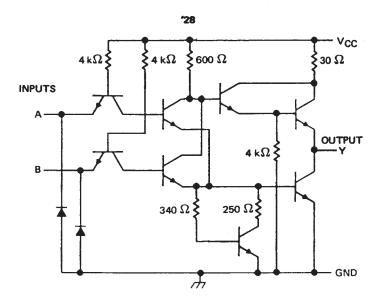


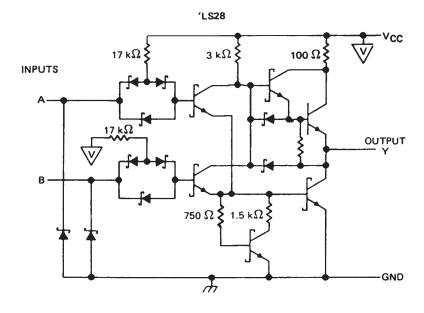
NC - No internal connection

## logic diagram



#### schematics (each gate)





Resistor values shown are nominal.

## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, V <sub>CC</sub> (see Note 1) | 7 V   |
|--|-------|
| Input voltage: '28                           | 5.5 V |
| 'LS28  | 7 V   |
| Operating free-air temperature: SN54'        |       |
| SN74'  |       |
| Storage temperature range                    |       |

NOTE 1: Voltage values are with respect to network ground terminal.



## recommended operating conditions

|                 |                                |      | SN5428 |       | SN7428 |     |       |          |
|-----------------|--------------------------------|------|--------|-------|--------|-----|-------|----------|
|                 |                                | MIN  | NOM    | MAX   | MIN    | NOM | MAX   | UNIT     |
| Vcc             | Supply voltage                 | 4.5  | 5      | 5.5   | 4.75   | 5   | 5.25  | ٧        |
| V <sub>IH</sub> | High-level input voltage       | 2    |        |       | 2      |     |       | ٧        |
| VIL             | Low-level input voltage        |      |        | 0.8   |        |     | 8.0   | <b>v</b> |
| ЮН              | High-level output current      |      |        | - 2.4 |        |     | - 2,4 | mA       |
| loL             | Low-level output current       |      |        | 48    |        |     | 48    | mA       |
| TA              | Operating free-air temperature | - 55 |        | 125   | 0      |     | 70    | °c       |

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER         |   |          | TEST CONDITIONS T       | MIN  | TYP‡ | MAX          | UNIT |
|-------------------|---|----------|-------------------------|------|------|--------------|------|
| VIK               | VCC = MIN, II =                         | – 12mA   |                         |      |      | - 1.5        | ٧    |
| v <sub>OН</sub> . | VCC = MIN, VIL                          | = 0.8 V, | IOH = - 2,4 mA          | 2.4  | 3.4  | -            | ٧    |
| V <sub>OL</sub>   | V <sub>CC</sub> = MIN, V <sub>IH</sub>  | = 2 V,   | I <sub>OL</sub> = 48 mA |      | 0.2  | 0.4          | ٧    |
| 1 <sub>1</sub>    | V <sub>CC</sub> = MAX, V <sub>I</sub> = | 5.5 V    |                         |      |      | 1            | mA   |
| Чн                | V <sub>CC</sub> = MAX, V <sub>I</sub> = | 2.4 V    |                         |      |      | 40           | μΑ   |
| HL.               | V <sub>CC</sub> = MAX, V <sub>1</sub> = | 0.4 V    |                         |      |      | -1.6         | mA   |
| IOS §             | V <sub>CC</sub> = MAX                   |          |                         | - 70 |      | <b>– 180</b> | mΑ   |
| <sup>1</sup> ссн  | V <sub>CC</sub> = MAX, V <sub>I</sub> = | 0 V      |                         |      | 12   | 21           | mA   |
| ICCL              | V <sub>CC</sub> = MAX, See I            | Note 2   |                         |      | 33   | 57           | mA   |

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

## switching characteristics, VCC = 5 V, TA = 25°C (see note 3)

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | TEST CONDITIONS                     | MIN | TYP | MAX | UNIT |
|------------------|-----------------|----------------|-------------------------------------|-----|-----|-----|------|
| <sup>t</sup> PLH |                 |                | $R_L = 133 \Omega$ , $C_L = 50 pF$  |     | 6   | 9   | ns   |
| <sup>t</sup> PHL |                 | .,             | NC = 133 32, CC = 30 pi             |     | 8   | 12  | ns   |
| <sup>t</sup> PLH | A or B          | A or B Y       | D 400 C 0 - 450 - 5                 |     | 10  | 15  | ns   |
| <sup>t</sup> PHL | !               |                | $R_L = 133 \Omega,$ $C_L = 150  pF$ |     | 12  | 18  | ns   |

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



<sup>‡</sup> All typical values are at VCC = 5 V, TA = 25°C.

<sup>§</sup> Not more than one output should be shorted at a time and the duration of the short circuit should not exceed one second. NOTE 2: One input at 4.5 V, all others at GND.

## SN5428, SN54LS28, SN7428, SN74LS28 QUADRUPLE 2-INPUT POSITIVE-NOR BUFFERS

SDLS094 - DECEMBER 1983 - REVISED MARCH 1988

## recommended operating conditions

|     |                                |      | SN54LS28 |       | SN74LS28 |     |       |      |
|-----|--------------------------------|------|----------|-------|----------|-----|-------|------|
|     |                                | MIN  | NOM      | MAX   | MIN      | NOM | MAX   | UNIT |
| Vcc | Supply voltage                 | 4.5  | 5        | 5.5   | 4.75     | 5   | 5.25  | ٧    |
| VIH | High-level input voltage       | 2    |          |       | 2        |     |       | ٧    |
| VIL | Low-level input voltage        |      |          | 0.7   |          |     | 0.8   | V    |
| Іон | High-level output current      |      |          | - 1.2 |          |     | - 1.2 | mA   |
| loL | Low-level output current       |      |          | 12    |          |     | 24    | mA   |
| TA  | Operating free-air temperature | - 55 |          | 125   | 0        |     | 70    | °c   |

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|                 | TEST CONDITIONS †      |                          |                            |      | SN54LS        | 28    |               | SN74LS | 28           |      |
|-----------------|------------------------|--------------------------|----------------------------|------|---------------|-------|---------------|--------|--------------|------|
| PARAMETER       |                        |                          |                            | MIN  | MIN TYP\$ MAX |       | MIN TYP\$ MAX |        | MAX          | UNIT |
| VIK             | V <sub>CC</sub> = MIN, | I <sub>I</sub> = - 18 mA |                            |      |               | - 1.5 |               |        | <b>– 1.5</b> | ٧    |
| Voн             | V <sub>CC</sub> = MIN, | VIL = MAX,               | I <sub>OH</sub> = - 1.2 mA | 2.5  | 3.4           |       | 2,7           | 3.4    |              | ٧    |
| V               | V <sub>CC</sub> = MIN, | V <sub>IH</sub> = 2 V,   | I <sub>OL</sub> = 12 mA    |      | 0.25          | 0.4   |               | 0.24   | 0.4          | V    |
| VOL             | V <sub>CC</sub> = MIN, | V <sub>IH</sub> = 2 V,   | I <sub>OL</sub> = 24 mA    |      |               |       |               | 0.35   | 0.5          | ľ    |
| 11              | V <sub>CC</sub> = MAX, | V <sub>1</sub> = 7 V     |                            |      |               | 0.1   |               |        | 0.1          | mA   |
| <sup>1</sup> ін | V <sub>CC</sub> = MAX, | V <sub>1</sub> = 2.7 V   |                            |      |               | 20    |               |        | 20           | μΑ   |
| IΙL             | V <sub>CC</sub> = MAX, | V <sub>1</sub> = 0.4 V   |                            |      |               | - 0.4 |               |        | - 0.4        | mA   |
| IOS §           | V <sub>CC</sub> = MAX  |                          |                            | - 30 |               | - 130 | - 30          |        | - 130        | mA   |
| 1ссн            | V <sub>CC</sub> = MAX, | V <sub>1</sub> = 0 V     |                            |      | 1.8           | 3.6   |               | 1.8    | 3.6          | 'nΑ  |
| CCL             | V <sub>CC</sub> = MAX, | See Note 2               |                            |      | 6.9           | 13.8  |               | 6.9    | 13.8         | mA   |

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

NOTE 2: One input at 4.5 V, all others at GND.

## switching characteristics, VCC = 5 V, TA = 25°C (see note 3)

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | TEST CONDITIONS                    | MIN T | TYP MA | X UNIT |
|------------------|-----------------|----------------|------------------------------------|-------|--------|--------|
| <sup>t</sup> PLH | A or B          | V              | $R_1 = 667 \Omega$ , $C_L = 45 pF$ |       | 12     | 24 ns  |
| <sup>t</sup> PHL | A 01 B          |                | n[ - 60/ 22,                       |       | 12     | 24 ns  |

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



<sup>‡</sup> All typical values are at  $V_{CC}$  = 5 V,  $T_A$  = 25°C.

<sup>§</sup> Not more than one output should be shorted at a time and the duration of the short circuit should not exceed one second,

#### PACKAGE OPTION ADDENDUM

www.ti.com 15-Oct-2009

#### **PACKAGING INFORMATION**

| Orderable Device | Status <sup>(1)</sup> | Package<br>Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|-----------------|--------------------|------|----------------|-------------------------|------------------|------------------------------|
| SN5428J          | ACTIVE                | CDIP            | J                  | 14   | 1              | TBD                     | A42              | N / A for Pkg Type           |
| SN7428N          | OBSOLETE              | PDIP            | N                  | 14   |                | TBD                     | Call TI          | Call TI                      |
| SN7428N          | OBSOLETE              | PDIP            | N                  | 14   |                | TBD                     | Call TI          | Call TI                      |
| SN7428N3         | OBSOLETE              | PDIP            | N                  | 14   |                | TBD                     | Call TI          | Call TI                      |
| SN7428N3         | OBSOLETE              | PDIP            | N                  | 14   |                | TBD                     | Call TI          | Call TI                      |
| SN74LS28D        | OBSOLETE              | SOIC            | D                  | 14   |                | TBD                     | Call TI          | Call TI                      |
| SN74LS28D        | OBSOLETE              | SOIC            | D                  | 14   |                | TBD                     | Call TI          | Call TI                      |
| SN74LS28DR       | OBSOLETE              | SOIC            | D                  | 14   |                | TBD                     | Call TI          | Call TI                      |
| SN74LS28DR       | OBSOLETE              | SOIC            | D                  | 14   |                | TBD                     | Call TI          | Call TI                      |
| SN74LS28N        | OBSOLETE              | PDIP            | N                  | 14   |                | TBD                     | Call TI          | Call TI                      |
| SN74LS28N        | OBSOLETE              | PDIP            | N                  | 14   |                | TBD                     | Call TI          | Call TI                      |
| SN74LS28N3       | OBSOLETE              | PDIP            | N                  | 14   |                | TBD                     | Call TI          | Call TI                      |
| SN74LS28N3       | OBSOLETE              | PDIP            | N                  | 14   |                | TBD                     | Call TI          | Call TI                      |
| SNJ5428J         | ACTIVE                | CDIP            | J                  | 14   | 1              | TBD                     | A42              | N / A for Pkg Type           |
| SNJ5428J         | ACTIVE                | CDIP            | J                  | 14   | 1              | TBD                     | A42              | N / A for Pkg Type           |
| SNJ5428W         | ACTIVE                | CFP             | W                  | 14   | 1              | TBD                     | A42              | N / A for Pkg Type           |
| SNJ5428W         | ACTIVE                | CFP             | W                  | 14   | 1              | TBD                     | A42              | N / A for Pkg Type           |

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

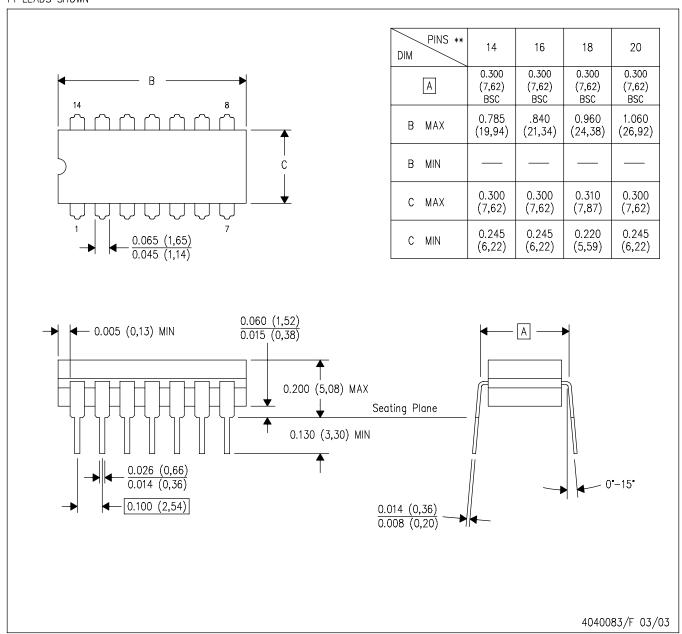
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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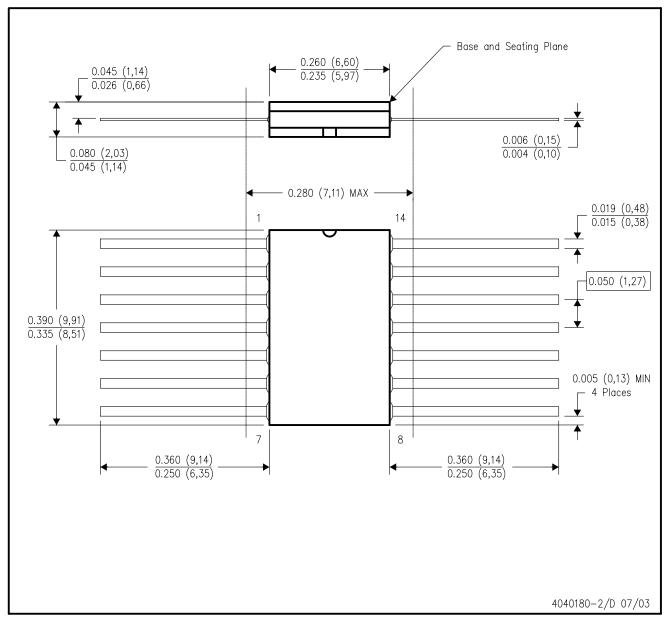
#### 14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

# W (R-GDFP-F14)

## CERAMIC DUAL FLATPACK



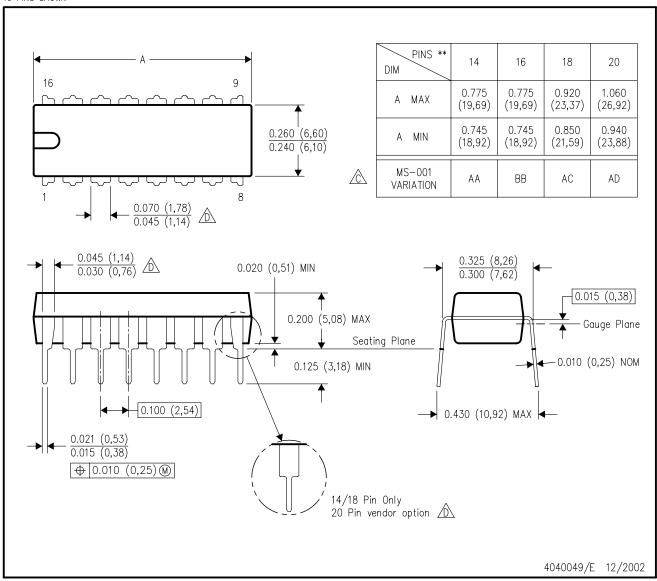
- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP1-F14 and JEDEC MO-092AB



# N (R-PDIP-T\*\*)

## PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN

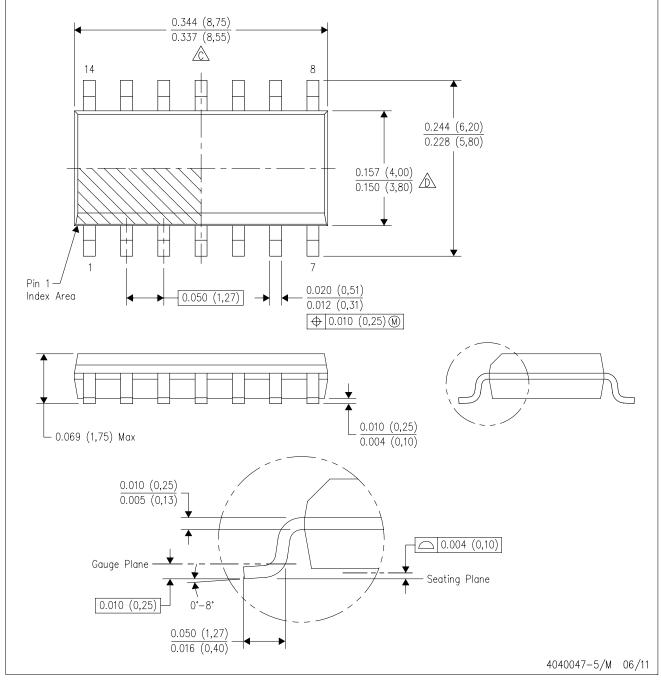


- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



# D (R-PDSO-G14)

## PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.



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